What Is Claimed Is:

- 1. A liquid crystal display device, comprising:
- a plurality of data lines arranged along a first direction on a substrate; a plurality of gate lines arranged a second direction perpendicular to the first direction on the substrate to define a plurality of pixel regions, each of the gate lines having at least one first set of protrusions and depressions;
 - a driving device within each of the pixel regions;
 - a pixel electrode within each of the pixel regions; and
- a metal layer overlapping each of the gate lines to create a storage capacitor.
- 2. The device according to claim 1, wherein the first set of protrusions and depressions is arranged along the second direction of the gate lines.
- 3. The device according to claim 2, wherein the first set of protrusions and depressions are arranged along the first direction of the data lines.
- 4. The device according to claim 2, wherein the first set of protrusions and depressions are arranged having a lattice shape.
- 5. The device according to claim 1, wherein the driving device includes a thin film transistor.
- 6. The device according to claim 5, wherein the thin film transistor includes:
 - a gate electrode on the substrate;
 - a gate insulating layer over the substrate;
 - a semiconductor layer on the gate insulating layer; and
 - a source electrode and a drain electrode on the semiconductor layer.
- 7. The device according to claim 6, further comprising at least one first protrusion/depression layer on the substrate to form the first set of protrusions and depressions.
- 8. The device according to claim 7, wherein the first protrusion/depression layer includes metal material.
- 9. The device according to claim 7, wherein the first protrusion/depression layer includes insulation material.

- 10. The device according to claim 6, further comprising at least one first groove formed within a surface of the substrate to form the first set of protrusions and depressions.
- 11. The device according to claim 6, wherein the metal layer is disposed on the gate insulating layer.
- 12. The device according to claim 11, wherein the metal layer includes metal material similar to metal material of the source electrode and the drain electrode.
- 13. The device according to claim 6, further comprising a second set of protrusions and depressions in the semiconductor layer.
- 14. The device according to claim 13, wherein the second set of protrusions and depressions is formed along the source electrode and the drain electrode.
- 15. The device according to claim 13, wherein the second set of protrusions and depressions is arranged in a lattice shape.
- 16. The device according to claim 13, further comprising a second protrusion/depression layer in the substrate to form the second set of protrusions and depressions.
- 17. The device according to claim 16, wherein the second protrusion/depression layer includes insulation material.
- 18. The device according to claim 16, wherein the second protrusion/depression layer includes metal material.
- 19. The device according to claim 13, further comprising a second groove formed in a surface of the substrate to form the second set of protrusions and depressions.
- 20. A liquid crystal display device, comprising:

a plurality of data lines and gate lines arranged in a substrate to define a plurality of pixel regions;

a thin film transistor within each pixel region and including a gate electrode on the substrate, a gate insulating layer on the substrate, a semiconductor layer on the gate insulating layer and having protrusions and

- depressions, a source electrode and a drain electrode on the semiconductor layer; a passivation layer on an entire surface of substrate; and a pixel electrode on the passivation layer.
- 21. The device according to claim 20, further comprising at least one protrusion/depression layer on the substrate to provide protrusions and depressions in the semiconductor layer.
- 22. The device according to claim 21, wherein the protrusion/depression layer includes insulation material.
- 23. The device according to claim 21, wherein the protrusion/depression layer includes metal material.
- 24. The device according to claim 21, wherein the protrusion/depression layer is arranged along a direction between the source electrode and the drain electrode.
- 25. The device according to claim 21, wherein the protrusion/depression layer is arranged having a lattice shape.
- 26. The device according to claim 20, further comprising at least one groove formed in a surface of the substrate to provide protrusions and depressions in the semiconductor layer.
- 27. The device according to claim 26, wherein the groove is formed along a direction between the source electrode and the drain electrode.
- 28. The device according to claim 26, wherein the groove is arranged having a lattice shape.
- 29. The device according to claim 20, further comprising a metal layer arranged along a direction of the gate line to form a storage capacitor.
- 30. The device according to claim 29, further comprising a protrusion/depression layer arranged along a direction of the gate line.
- 31. The device according to claim 29, further comprising a groove formed along a direction of the gate line.

32. A method of fabricating a liquid crystal display device, comprising:
forming a plurality of data lines arranged along a first direction on a substrate;

forming a plurality of gate lines arranged a second direction perpendicular to the first direction on the substrate to define a plurality of pixel regions, each of the gate lines having at least one first set of protrusions and depressions;

forming a driving device within each of the pixel regions; forming a pixel electrode within each of the pixel regions; and forming a metal layer overlapping each of the gate lines to create a storage capacitor.

- 33. The method according to claim 32, wherein the first set of protrusions and depressions is arranged along the second direction of the gate lines.
- 34. The method according to claim 33, wherein the first set of protrusions and depressions are arranged along the first direction of the data lines.
- 35. The method according to claim 33, wherein the first set of protrusions and depressions are arranged having a lattice shape.
- 36. The method according to claim 32, wherein the driving device includes a thin film transistor.
- 37. The method according to claim 36, wherein the thin film transistor includes:
 - a gate electrode on the substrate;
 - a gate insulating layer over the substrate;
 - a semiconductor layer on the gate insulating layer; and
 - a source electrode and a drain electrode on the semiconductor layer.
- 38. The method according to claim 37, further comprising forming at least one first protrusion/depression layer on the substrate to form the first set of protrusions and depressions.
- 39. The method according to claim 38, wherein the first protrusion/depression layer includes metal material.
- 40. The method according to claim 38, wherein the first protrusion/depression layer includes insulation material.

- 41. The method according to claim 37, further comprising forming at least one first groove within a surface of the substrate to form the first set of protrusions and depressions.
- 42. The method according to claim 37, wherein the metal layer is disposed on the gate insulating layer.
- 43. The method according to claim 42, wherein the metal layer includes metal material similar to metal material of the source electrode and the drain electrode.
- 44. The method according to claim 37, further comprising forming a second set of protrusions and depressions in the semiconductor layer.
- 45. The method according to claim 44, wherein the second set of protrusions and depressions is formed along the source electrode and the drain electrode.
- 46. The method according to claim 45, wherein the second set of protrusions and depressions is arranged in a lattice shape.
- 47. The method according to claim 44, further comprising forming a second protrusion/depression layer in the substrate to form the second set of protrusions and depressions.
- 48. The method according to claim 47, wherein the second protrusion/depression layer includes insulation material.
- 49. The method according to claim 47, wherein the second protrusion/depression layer includes metal material.
- 50. The method according to claim 44, further comprising forming a second groove in a surface of the substrate to form the second set of protrusions and depressions.